



**THE DATASHEET OF
KFDIP2004L157B1U**



APPROVAL SHEET

KFDIP Series – 2012(0805)- RoHS Compliance

MULTILAYER CERAMIC DIPLEXER

Halogens Free Product

2.4 GHz & 5 GHz ISM Band RF Application

P/N: KFDIP2004L157B1U

*Contents in this sheet are subject to change without prior notice.

FEATURES

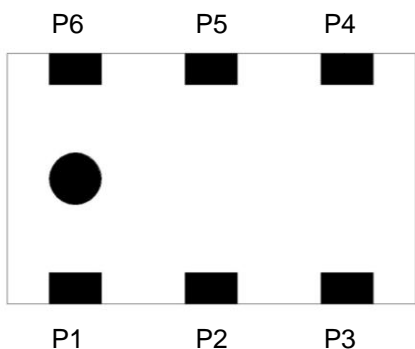
1. Miniature footprint: 2.0 X 1.25 X 0.4 mm³.
2. LTCC Process
3. Low Profile Thickness
4. Low Insertion Loss
5. High Rejection
6. RoHS Compliance
7. Halogens Free Product

APPLICATIONS

1. 2400 ~ 2500 MHz and 4900 ~ 5950 MHz working frequency

CONSTRUCTION

Top view



| PIN | Connection | PIN | Connection |
|-----|------------------|-----|-------------------|
| 1 | GND | 4 | Higher Freq. Port |
| 2 | Common(ANT) Port | 5 | GND |
| 3 | GND | 6 | Lower Freq. Port |

DIMENSIONS

| Figure | Symbol | Dimension (mm) |
|--|--------|----------------|
| <p>The figure shows three views of the component with dimension lines: - Top view: Shows overall length L and width W. - Bottom view: Shows the thickness of the pads, labeled E. - Side view: Shows the total thickness T, and the thicknesses of the individual layers: A, B, C, and D.</p> | L | 2.00 ± 0.15 |
| | W | 1.25 ± 0.15 |
| | T | 0.40 ± 0.10 |
| | A | 0.20 ± 0.15 |
| | B | 0.30 ± 0.15 |
| | C | 0.35 ± 0.15 |
| | D | 0.65 ± 0.15 |
| | E | 0.20 ± 0.15 |

RELIABILITY TEST

| Test item | Test condition / Test method | Specification |
|--|--|---|
| Solderability JIS C 0050-4.6 JESD22-B102D | *Solder bath temperature : $235 \pm 5^{\circ}\text{C}$ *Immersion time : 2 ± 0.5 sec Solder : Sn3Ag0.5Cu for lead-free | At least 95% of a surface of each terminal electrode must be covered by fresh solder. |
| Leaching (Resistance to dissolution of metallization) IEC 60068-2-58 | *Solder bath temperature : $260 \pm 5^{\circ}\text{C}$ *Leaching immersion time : 30 ± 0.5 sec Solder : SN63A | Loss of metallization on the edges of each electrode shall not exceed 25%. |
| Resistance to soldering heat JIS C 0050-5.4 | *Preheating temperature : $120\sim 150^{\circ}\text{C}$, 1 minute. *Solder temperature : $270\pm 5^{\circ}\text{C}$ *Immersion time : 10 ± 1 sec Solder : Sn3Ag0.5Cu for lead-free Measurement to be made after keeping at room temperature for 24 ± 2 hrs | No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within $-40 \sim 85^{\circ}\text{C}$. Loss of metallization on the edges of each electrode shall not exceed 25%. |
| Drop Test JIS C 0044 Customer's specification. | *Height : 75 cm *Test Surface : Rigid surface of concrete or steel. *Times : 6 surfaces for each units ; 2 times for each side. | No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within $-40 \sim 85^{\circ}\text{C}$. |
| Vibration JIS C 0040 | *Frequency : 10Hz~55Hz~10Hz(1min) *Total amplitude : 1.5mm *Test times : 6hrs.(Two hrs each in three mutually perpendicular directions) | No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within $-40 \sim 85^{\circ}\text{C}$. |
| Adhesive Strength of Termination JIS C 0051- 7.4.3 | *Pressurizing force : 5N(≤ 0603) ; 10N(>0603) *Test time : 10 ± 1 sec | No remarkable damage or removal of the termination. |
| Bending test JIS C 0051- 7.4.1 | The middle part of substrate shall be pressurized by means of the pressurizing rod at a rate of about 1 mm/s per second until the deflection becomes 1mm/s and then pressure shall be maintained for 5 ± 1 sec. Measurement to be made after keeping at room temperature for 24 ± 2 hours | No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within $-40 \sim 85^{\circ}\text{C}$. |

Approval sheet

| | | |
|--|--|---|
| <p>Temperature cycle JIS C 0025</p> | <p>1. 30±3 minutes at -40°C±3°C, 2. 10~15 minutes at room temperature, 3. 30±3 minutes at +85°C±3°C, 4. 10~15 minutes at room temperature, Total 100 continuous cycles Measurement to be made after keeping at room temperature for 24±2 hrs</p> | <p>No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.</p> |
| <p>High temperature JIS C 0021</p> | <p>*Temperature : 85°C±2°C *Test duration : 1000+24/-0 hours Measurement to be made after keeping at room temperature for 24±2 hrs</p> | <p>No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.</p> |
| <p>Humidity (steady conditions) JIS C 0022</p> | <p>*Humidity : 90% to 95% R.H. *Temperature : 40±2°C *Time : 1000+24/-0 hrs. Measurement to be made after keeping at room temperature for 24±2 hrs ※ 500hrs measuring the first data then 1000hrs data</p> | <p>No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.</p> |
| <p>Low temperature JIS C 0020</p> | <p>*Temperature : -40°C±2°C *Test duration : 1000+24/-0 hours Measurement to be made after keeping at room temperature for 24±2 hrs</p> | <p>No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.</p> |

SOLDERING CONDITION

Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 2,

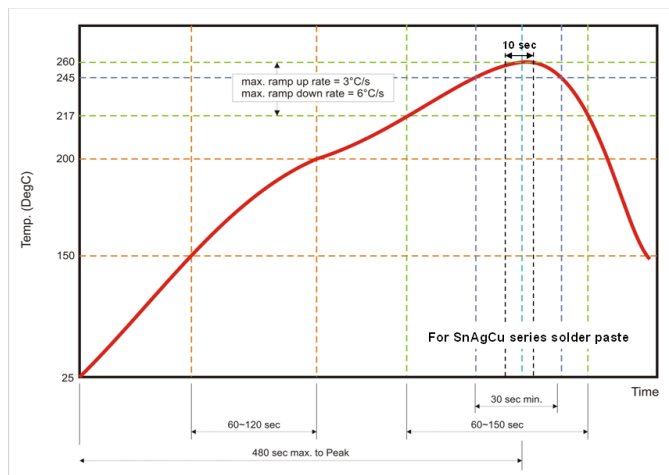


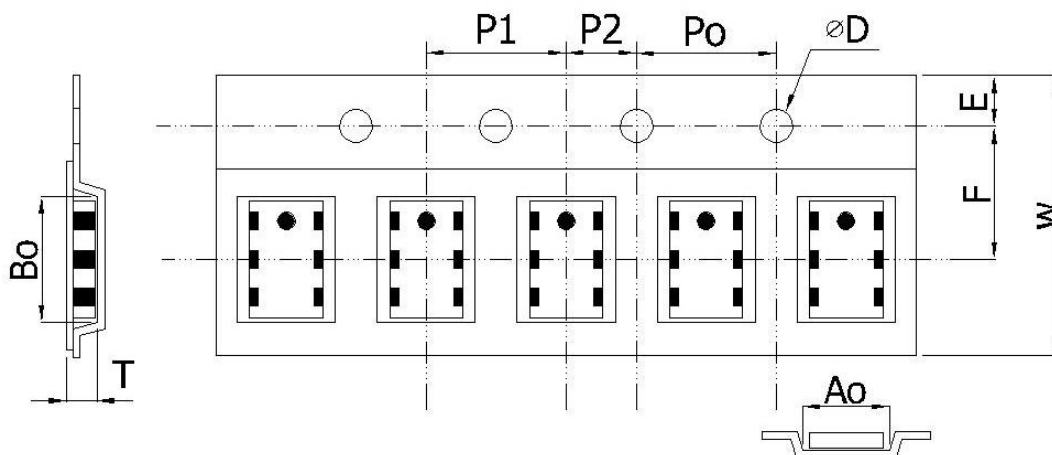
Fig 2. Infrared soldering profile

ORDERING CODE

| | | | | | |
|----------------------------------|--|---|--|---|---|
| KF Walsin RF device | DIP Product Code DIP : Diplexer | 20 Dimension code Per 2 digits of Length, Width,; e.g. : 20 = Length 20, Width 12, | 04 Dimension code 04= Thickness 04 | L Application L : 2.4GHz/5GHz | 157B1U Specification Design code |
|----------------------------------|--|---|--|---|---|

Minimum Ordering Quantity: 2000 pcs per reel.

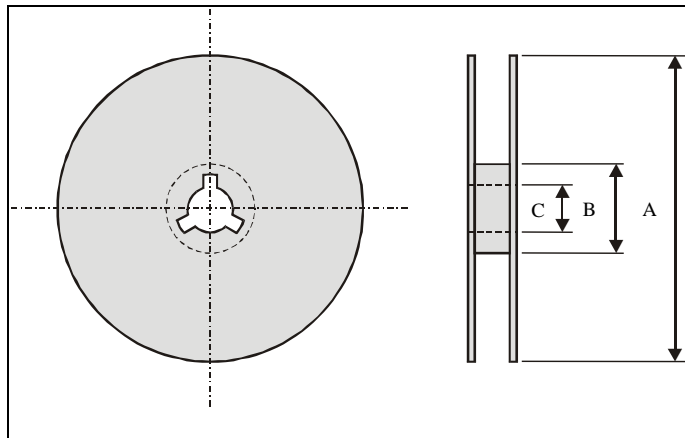
PACKAGING



Plastic Tape specifications (unit :mm)

| | | | | | |
|----------------|-------------|-------------|-------------|-------------|-------------|
| Index | Ao | B0 | ΦD | T | W |
| Dimension (mm) | 1.40 ± 0.10 | 2.25 ± 0.10 | 1.55 ± 0.05 | 0.75 ± 0.10 | 8.0 ± 0.10 |
| Index | E | F | Po | P1 | P2 |
| Dimension (mm) | 1.75 ± 0.10 | 3.50 ± 0.05 | 4.00 ± 0.10 | 4.00 ± 0.10 | 2.00 ± 0.05 |

Reel dimensions



| | | | |
|----------------|--------|-------|-------|
| Index | A | B | C |
| Dimension (mm) | Φ178.0 | Φ60.0 | Φ13.0 |

Taping Quantity:2000 pieces per 7" reel

CAUTION OF HANDLING

Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects, which might directly cause damage to the third party's life, body or property.

- (1) Aircraft equipment
- (2) Aerospace equipment
- (3) Undersea equipment
- (4) Medical equipment
- (5) Disaster prevention / crime prevention equipment
- (6) Traffic signal equipment
- (7) Transportation equipment (vehicles, trains, ships, etc.)
- (8) Applications of similar complexity and /or reliability requirements to the applications listed in the above.

Storage condition

- (1) Products should be used in 6 months from the day of WALSIN outgoing inspection, which can be confirmed.
- (2) Storage environment condition.
 - Products should be storage in the warehouse on the following conditions.
 - Temperature : -10 to +40°C
 - Humidity : 30 to 70% relative humidity
 - Don't keep products in corrosive gases such as sulfur. Chlorine gas or acid or it may cause oxidization of electrode, resulting in poor solderability.
 - Products should be storage on the palette for the prevention of the influence from humidity, dust and son on.
 - Products should be storage in the warehouse without heat shock, vibration, direct sunlight and so on.
 - Products should be storage under the airtight packaged condition.

Looking for pricing, stock, or lifecycle information?

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- ✓ Alternative Solution
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